[Cover]

[Document Filed] Amendment Report for Annual Securities Report

[Applicable Law] Article 24-2, Paragraph 1 of the Financial Instruments and Exchange Act

of Japan

[Filed to] Director of General of the Kanto Local Finance Bureau

[Filing Date] May 9, 2024

[Fiscal Year] 22nd Fiscal Year (from January 1, 2023 to December 31, 2023)

[Company Name] Renesas Electronics Kabushiki-kaisha

[Company Name (English)] Renesas Electronics Corporation

[Title and Name of Representative] Hidetoshi Shibata, Representative Executive Officer, President and CEO

[Address of Head Office] 2-24, Toyosu 3-chome, Koto-ku, Tokyo, Japan

[Phone No.] 03 (6773) 3000 (switchboard)

[Contact Person] Yukitake Hashiguchi, Director, Legal Division

[Contact Address] 2-24, Toyosu 3-chome, Koto-ku, Tokyo, Japan

[Phone No.] 03 (6773) 3000 (switchboard)

[Contact Person] Yukitake Hashiguchi, Director, Legal Division

Place Where Available for Public Tokyo Stock Exchange, Inc.

Inspection] (2-1, Nihombashi Kabutocho, Chuo-ku, Tokyo)

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1 [Reason for Filing Amendment Report for Annual Securities Report]

There were some errors in the Annual Securities Report for the 22nd fiscal year (from January 1, 2023 to December 31, 2023) submitted on March 28, 2024, so the Company hereby files this Amendment Report for Annual Securities Report for the 22nd fiscal period to amend those errors.

2 [Amendment Part]

Part I. Corporate Information

- I. Company Overview
 - 4. Status of Affiliated Companies

3 [Content of the Amendment]

The amended parts are underlined.

Part I. Corporate Information

I. Company Overview

4. Status of Affiliated Companies

(Before amendment)

Name	Address	Share capital or investments (Million yen, or currency noted)	Major business	Voting rights holding/held ratio (%) (Note 1)	Relationship				
<omitted></omitted>									
Renesas Semiconductor (Suzhou) (Note 2)	China Suzhou	Thousand US dollars 43,226	Manufacture of semiconductor products (backend process)	(0.00.0	Manufacture of the Company products Loans - None Real estate/equipment leasing - None Interlocking directorates - None				
<omitted></omitted>									

(Note) < Omitted>

(After amendment)

Name	Address	Share capital or investments (Million yen, or currency noted)	Major business	Voting rights holding/held ratio (%) (Note 1)	Relationship				
<omitted></omitted>									
Renesas Semiconductor (Suzhou)	China Suzhou	Thousand US dollars 43,226	Manufacture of semiconductor products (back- end process)	(6.33)	Manufacture of the Company products Loans - None Real estate/equipment leasing - None Interlocking directorates - None				
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(Note) < Omitted>